Accu-Guard®

Introduction



ACCU-GUARD® TECHNOLOGY

The Accu-Guard® series of fuses is based on thin-film techniques. This technology provides a level of control on the component electrical and physical characteristics that is generally not possible with standard fuse technologies. This has allowed KYOCERA AVX to offer a series of devices which are designed for modern surface mount circuit boards which require protection.

FEATURES

- Accurate current rating
- Fast acting
- Small-standard 0402, 0603, 0805, 1206 and 0612 chip sizes
- Taped and reeled
- Completely compatible with all soldering systems used for SMT
- Lead Free Series (F0402G, F0603G, F0402E, F0603E, F0805B, F1206B)

APPLICATIONS

- · Two-Way Radios
- Home Appliances
- · Battery Management Systems
- **Battery Chargers**
- Rechargeable Battery Packs
- Computers
- Hard Disk Drives
- PDA's
- LCD Screens
- SCSI Interface
- **Digital Cameras**
- Video Cameras

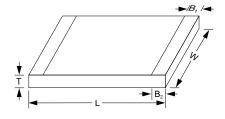


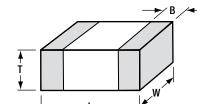
APPROVAL FILE NUMBERS

UL, cUL: RCD#E143842

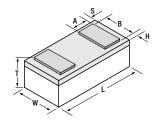
DIMENSIONS millimeters (inches)

F0603C, F0805B, F1206A and F1206B





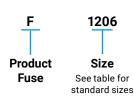
F0402E and F0603E



F0402G and F0603G

| | F0402G | F0603G | F0402E | F0603E | F0603C | F0805B | F1206A/B | F0612D |
|------|----------------------------|----------------------------|---------------|---------------|---------------|---------------|---------------|---------------|
| L | 1.00±0.05 | 1.60±0.10 | 1.00±0.10 | 1.60±0.10 | 1.65±0.25 | 2.10±0.20 | 3.10±0.20 | 1.65±0.25 |
| | (0.039±0.002) | (0.063±0.004) | (0.039±0.004) | (0.063±0.004) | (0.065±0.010) | (0.083±0.008) | (0.122±0.008) | (0.065±0.010) |
| w | 0.58 ±0.04 | 0.81±0.10 | 0.55±0.07 | 0.81±0.10 | 0.80±0.15 | 1.27±0.10 | 1.60±0.10 | 3.10±0.20 |
| | (0.023±0.002) | (0.032±0.004) | (0.022±0.003) | (0.032±0.004) | (0.031±0.006) | (0.050±0.004) | (0.063±0.004) | (0.122±0.008) |
| Т | 0.35±0.05 | 0.61±0.10 | 0.40±0.10 | 0.63±0.10 | 0.70±0.15 | 0.90±0.2 | 1.20±0.20 | 0.90±0.20 |
| | (0.014±0.002) | (0.024±0.004) | (0.016±0.004) | (0.025±0.004) | (0.028±0.006) | (0.035±0.008) | (0.047±0.008) | (0.036±0.008) |
| В | 0.48±0.05 | 0.71±0.05 | 0.20±0.10 | 0.35±0.15 | 0.35±0.15 | 0.30±0.15 | 0.43±0.25 | 0.35±0.15 |
| | (0.019±0.002) | (0.028±0.002) | (0.008±0.004) | (0.014±0.006) | (0.014±0.006) | (0.012±0.006) | (0.017±0.010) | (0.014±0.006) |
| Α | 0.20±0.05 (0.008±0.002) | 0.28±0.05 (0.011±0.002) | | | | | | |
| S, H | 0.05±0.05 (0.002±0.002) | 0.06±0.05 (0.002±0.002) | | | | | | |

HOW TO ORDER





Fuse Version

A=Accu-Guard® B=Accu-Guard® II C=Accu-Guard® II 0603 D=Accu-Guard® II 0612 E=Accu-Guard® II 0402, 0603 G=Accu-Guard® II Low Current 0402,0603



Rated Current

Current expressed in Amps. Letter R denotes decimal point e.g. 0.20A=0R20 1.75A=1R75



Fuse Speed

F=Fast

Termination

S=Nickel/Lead-Free Solder coated (Sn 100), SMD W=Nickel/solder coated (Sn 63, Pb 37) Solder Coated (Sn100) N=Nickel/Lead-Free

Solder Coated (Sn100), LGA





Packaging TR=Tape and reel

Accu-Guard® II Low Current





The new F0402G and F0603G Accu-Guard® series of fuses is based on thin-film technology which allows precise control of the component electrical and physical characteristics that is not possible with standard fuse technologies. The Accu-Guard Low Current series encompasses the lowest current ratings in compact 0402 and 0603 packages and features LGA terminations.

ELECTRICAL SPECIFICATIONS

Operating temperature: -55°C to +125°C Current carrying capacity:

> -55°C to -11°C 107% of rating -10°C to +60°C 100% of rating +61°C to +100°C 85% of rating +101°C to +125°C 80% of rating

Rated voltage: 63V (F0603G), 32V (F0402G)

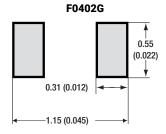
Post-fusing resistance: $>1M\Omega$

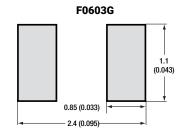
Interrupt rating: 50A

RECOMMENDED PAD LAYOUT

millimeters (inches)







| Part Number | Current Rating A | Resistance @0.1 x I rated Ω (max.) | Voltage Drop @ I rated mV (max.) | Fusing Current (within 5 sec) A | Pre-Arc I2t @10x I rated A²- sec (typ) | Color Code |
|-------------------------------|------------------------|--|--|---------------------------------------|--|---------------|
| F0402G0R02FNTR F0603G0R02FNTR | 0.028 | 7.5 | 290 | 0.070 | 6 x 10 ⁻⁷ | Green |
| F0402G0R03FNTR F0603G0R03FNTR | 0.0375 | 4.8 | 230 | 0.094 | 8 x 10 ⁻⁷ | Red |
| F0402G0R05FNTR F0603G0R05FNTR | 0.050 | 3.4 | 250 | 0.125 | 2 x 10 ⁻⁶ | Blue |
| F0402G0R06FNTR F0603G0R06FNTR | 0.062 | 2.5 | 280 | 0.155 | 2 x 10 ⁻⁶ | Yellow |
| F0402G0R07FNTR F0603G0R07FNTR | 0.075 | 2.0 | 280 | 0.188 | 4 x 10 ⁻⁶ | Brown |
| F0402G0R10FNTR F0603G0R10FNTR | 0.100 | 2.4 | 300 | 0.250 | 7 x 10 ⁻⁶ | Red |
| F0402G0R12FNTR F0603G0R12FNTR | 0.125 | 1.6 | 250 | 0.312 | 1 x 10 ⁻⁵ | White |
| F0402G0R15FNTR F0603G0R15FNTR | 0.150 | 1.2 | 220 | 0.375 | 2 x 10 ⁻⁵ | Green |
| F0402G0R20FNTR F0603G0R20FNTR | 0.200 | 0.8 | 210 | 0.500 | 4 x 10 ⁻⁵ | Pink |

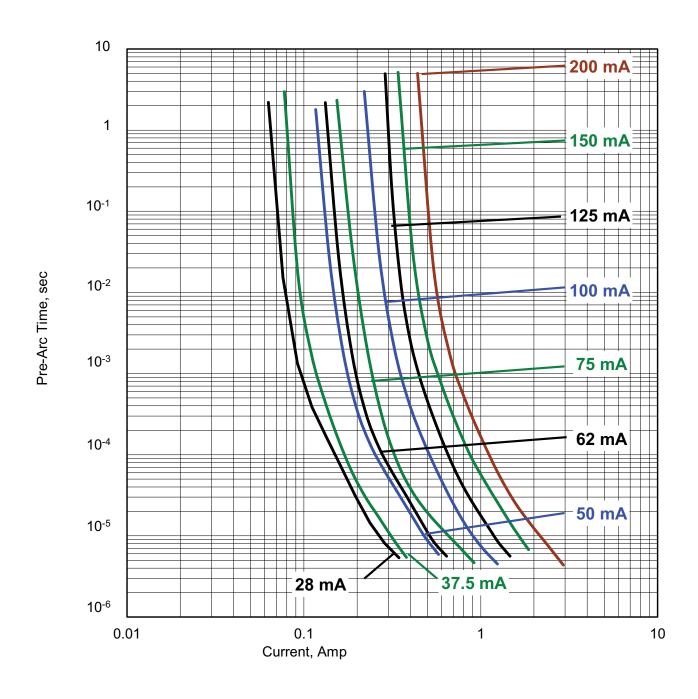
ENVIRONMENTAL CHARACTERISTICS

| Test | Conditions | Required | | |
|------------------------|--|--|--|--|
| Solderability | Components completely immersed in a solder bath at 245 ±5°C for 3 secs. | Total area of imperfections in solder coatup to 5% of the land suface area | | |
| Leach Resistance | Components completely immersed in a solder bath at 255 ±5°C for 60 secs. | Dissolution of termination ≤ 15% of the land surface area | | |
| Storage | 12 months minimum with components stored in "as received" packaging. | Good solderability | | |
| Shear | Components mounted to a substrate. Increasing shearing force applied paralled to the sufstrate till destruction. | Destruction at 5N force minimum | | |
| Temperature Cycling | Components mounted to a flexible substrate (e.g. FR – 4). 1000 cycles -55°C to +125°C. | No Visible damage ΔR/R<10% | | |
| Bend | Tested as shown in diagram 3 mm Deflection 45mm 45mm | No visible damage ΔR/R<10% | | |

Accu-Guard® II Low Current LGA Miniature 0402 and 0603 Size Thin-Film Fuses

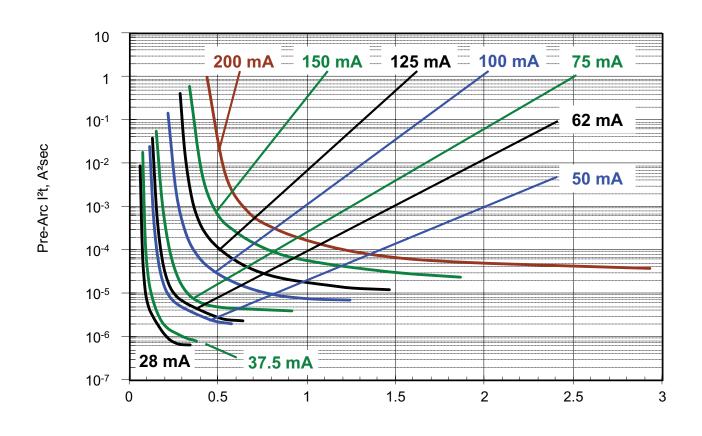


FUSE TIME-CURRENT CHARACTERISTICS





FUSE PRE-ARC JOULE INTEGRALS VS CURRENT



Current, Amp



FUSE PRE-ARC JOULE INTEGRALS VS PRE-ARC TIME

